ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® INCLUSTRES®	. Bannockb	ourn. Illinois. A	Il rights reserved untions.	under both	This docum level parts, t	ent is a declara he declaration	ion of the s encompasse	ubstances es all lowe	within the r level mate	manufacture erials for wh	er listed iten hich the man	n. Note: nufacture	if the item is an as er has engineering	ssembly with lower responsibility.
	I.1IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175xForm Distr				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and M					ils and Mfg	Informa	tion		
Supplier Information														
Company name* Co			Company unique ID			Unique ID Authority					Response Date*			
nsemi											2023-06-08			
ontact Name Title - Contact						Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product Env			Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative			resentative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro Com			ro Compliance	Compliance			NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		ber Mfr Item Name			Effective Dat	e Version]	Manufacturing Site		W	eight*	UOM	Unit Type
	CAT5113ZI-10-T3		DPP, NV 100 TAPS, U/D			2023-06-08		-	TH6		23	.37	mg	Each
Manufacturing Proccess Informatio	'n						-							
Terminal Plating / Grid Array Mater	d Array Material Terminal Base A		Alloy	J-STD-020 MSL Rating		Peak Pro	Peak Process Body Temperatu		are Max Time at Peak Tempera		Temperatur	e Num	ber of Reflow Cy	cles
Matte Tin (Sn) - annealed CU Alloy			1		260		C	30		seconds				
Comments														
level 1 - maximum time at peak temperature	during sol	dering is 10-3	0 seconds											
For more information regarding material co	mposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.19	mg	Supplier	Silicon (Si)	7440-21-3		1.19	mg
Die Attach 0.	0.16	mg	Supplier	Silver (Ag)	7440-22-4		0.12	mg
			Supplier	Epoxy resins	129915-35-1		0.04	mg
Lead Frame 8.2	8.28	mg	Supplier	Silver (Ag)	7440-22-4		0.2335	mg
			Supplier	Magnesium (Mg)	7439-95-4		0.0124	mg
			Supplier	Silicon (Si)	7440-21-3		0.0538	mg
			В	Nickel (Ni)	7440-02-0		0.2484	mg
			Supplier	Copper (Cu)	7440-50-8		7.7319	mg
Mold Compound-Black	13.13	mg		Epoxy Phenol Resin	proprietary data		1.3786	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		11.7513	mg
Plating	0.48	mg	Supplier	Tin (Sn)	7440-31-5		0.48	mg
Wire Bond - Au	0.13	mg	Supplier	Gold (Au)	7440-57-5		0.13	mg